



PATENT  
3273-0142P

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IN THE U.S. PATENT AND TRADEMARK OFFICE

APPLICANT: Hiroaki ARITA      CONF.: 3973  
SERIAL NO: 09/869,425      GROUP: 1711  
FILED: June 27, 2001      EXAMINER: Umakant RAJGURU  
FOR: RESIN COMPOSITION HAVING IMPROVED IMPACT  
RESISTANCE AT LOW TEMPERATURES

**AMENDMENT UNDER 37 C.F.R. § 1.111**

Assistant Commissioner for Patents  
Washington, D.C. 20231

July 8, 2002

Sir:

#6

Responsive to the Office Action of April 8, 2002, amend this application as follows.

IN THE CLAIMS:

Amend claims 1, 2, and 4-6 to read:

Sub C1  
1. (amended) A resin composition comprising a polyamide-based thermoplastic elastomer and a glycol or its derivative.

2. (amended) A resin composition comprising a polyether amide block copolymer as a thermoplastic elastomer and a glycol or its derivative.

Sub C3  
3. (amended) A resin composition according to claim 1 or 2, wherein said glycol or its derivative is a compound represented by the following Formula (1):